

SSC8035GS6A

P-Channel Enhanced MOSFET

Features

VDS	VGS	RDSON Typ.	ID	
		46mR@-10V		
-30V	-30V ±12V	54mR@-4V5	-4.2A	
		72mR@-2V5		

> Description

The SSC8035GS6A is P-Channel enhancement MOS Field Effect Transistor. Uses advanced trench technology and design to provide excellent RDSON with low gate charge. This device is suitable for use in DC-DC conversion and power switch applications.

> Applications

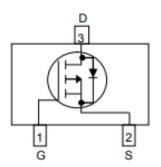
- Load Switch
- Portable Switch
- DCDC conversion
- Charging
- Driver for Relay, Motor, Solenoid,
 LED etc.

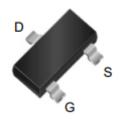
Ordering Information

Device	Package	Shipping	
SSC8035GS6A	SOT-23-3L	3000/Reel	

> Pin configuration

Top view





SOT-23-3L



Marking



➤ Absolute Maximum Ratings(T_A=25°C unless otherwise noted)

Symbol	Parameter	Ratings	Unit
V_{DSS}	Drain-to-Source Voltage	-30	V
V _{GSS}	Gate-to-Source Voltage	±12	٧
I _D	Continuous Drain Current ^a	-4.2	Α
I _{DM}	Pulsed Drain Current ^b	-20	Α
P _D	Power Dissipation ^c	1.45	W
P _{DSM}	Power Dissipation ^a	0.93	W
TJ	Operation junction temperature	-55 to 150	°C
T _{STG}	Storage temperature range	-55 to 150	°C

➤ Thermal Resistance Ratings(T_A=25°C unless otherwise noted)

Symbol	Parameter	Typical	Maximum	Unit
R _{0JA}	Junction-to-Ambient Thermal Resistance ^a		140	°C/W
Rejc	Junction-to-Case Thermal Resistance		90	C/VV

Note:

- a. The value of $R_{\theta JA}$ is measured with the device mounted on 1 in² FR-4 board with 2oz.copper,in a still air environment with T_A =25°C. The value in any given application depends on the user is specific board design. The current rating is based on the t \leq 10s thermal resistance rating.
- b. Repetitive rating, pulse width limited by junction temperature.
- c. The power dissipation P_D is based on $T_{J(MAX)}$ =150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.

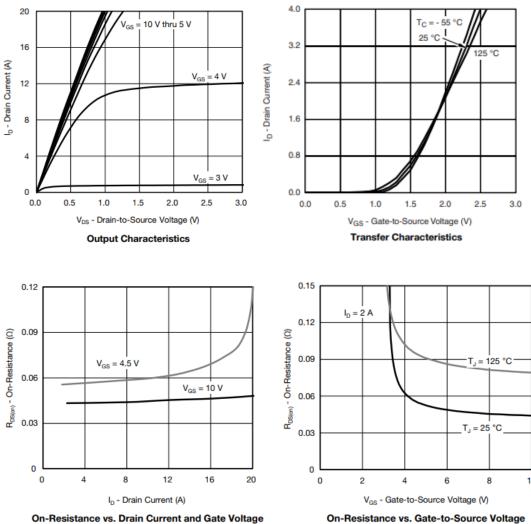


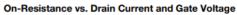
➤ Electronics Characteristics(T_A=25°C unless otherwise noted)

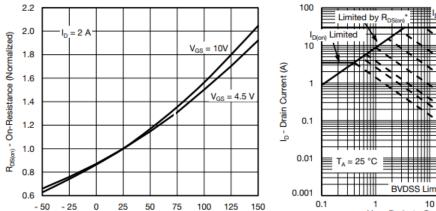
Symbol	Parameter	Test Conditions	Min	Тур.	Max	Unit
V _{(BR)DSS}	Drain-Source Breakdown Voltage	VGS=0V , ID=-250uA	-30			V
V _{GS (th)}	Gate Threshold Voltage	VDS=VGS , ID=-250uA	-0.6	-0.9	-1.3	V
	Drain-Source On-	VGS=-10V , ID=-4A		46	65	
R _{DS(on)}	Resistance	VGS=-4.5V , ID=-2A		54	75	mR
	Resistance	VGS=-2.5V , ID=-1A		72	110	
I _{DSS}	Zero Gate Voltage Drain Current	VDS=-30V , VGS=0V			-1	uA
I _{GSS}	Gate-Source leak	VGS=±12V , VDS=0V			±100	nA
G _{FS}	Transconductance	VDS=-10V , ID=-5A		9		s
V _{SD}	Forward Voltage	VGS=0V , IS=-2A			1.3	V
Ciss	Input Capacitance			980		
Coss	Output Capacitance	VDS=-15V , VGS=0V,		133		pF
Crss	Reverse Transfer Capacitance	f=1MHz		101		
T _{D(ON)}	Turn-on delay time			11		
Tr	Rise time	VGS=-10V, RL=15R		6		
T _{D(OFF)}	Turn-off delay time	VDS=-15V , RG=6R, ID=-4.2A		40		ns
Tf	Fall time			9		
Q _G	Total Gate Charge			18		
Q _{GS}	Gate to Source Charge	VGS=-10V, VDS=-15V ID=-4.2A		2.7		nC
Q _{GD}	Gate to Drain Charge	. <u> </u>		3.9		



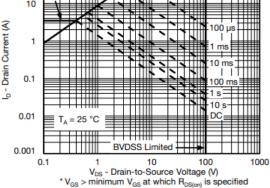
Typical Characteristics(T_A=25 °C unless otherwise noted)







T_J - Junction Temperature (°C) On-Resistance vs. Junction Temperature

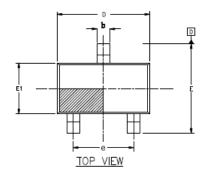


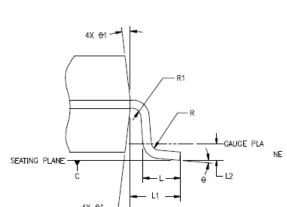
Safe Operating Area, Junction-to-Ambient

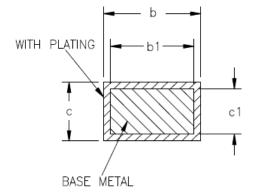
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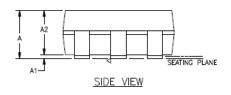


Package Information









SYMBOL	MIN	NOM	MAX
A			1.35
A1	0		0.15
A2	1.0	1.1	1.2
Ъ	0.35		0.45
ь1	0.32	-	0.38
с	0.14		0.20
c1	0.14	0.15	0.16
D	2.82	2.92	3.02
E	2.60	2.80	3.00
E1	1.526	1.626	1.726
е	1.8	1.9	2.0
L	0.35	0.45	0.6
L1	0.6REF		
L2	0.25REF		
R	0.1		
R1	0.1		
θ	0°	4°	8°
0 1	5°	10°	15°

NOTES: 1.All DIMENSIONS REFER TO JEDEC STANDARD

2.DIMENSION D DOES NOT INCLUDE MOLD FLASH
3.DIMENSION E1 DOSE NOT INCLUDE MOLD FLASH
4.FLASH OR PROTRUSION SHALL NOT EXCERD
0.25mm PER SIDE.

SOT23-3L

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